# CA3318

CMOS Video Speed, 8-Bit, Flash A/D Converter

August 1997

#### Features

•	CMOS Low Power with SOS Speed (Typ) 150mW
•	Parallel Conversion Technique
•	15MHz Sampling Rate (Conversion Time) 67ns
•	8-Bit Latched Three-State Output with Overflow Bit
•	Accuracy (Typ) ±1 LSB
•	Single Supply Voltage 4V to 7.5V
	2 Units in Series Allow 9-Bit Output

# 2 Units in Parallel Allow 30MHz Sampling Rate Applications

- TV Video Digitizing (Industrial/Security/Broadcast)
- High Speed A/D Conversion
- Ultrasound Signature Analysis
- Transient Signal Analysis
- High Energy Physics Research
- General-Purpose Hybrid ADCs
- Optical Character Recognition
- Radar Pulse Analysis
- Motion Signature Analysis
- μP Data Acquisition Systems

### Description

The CA3318 is a CMOS parallel (FLASH) analog-to-digital converter designed for applications demanding both low power consumption and high speed digitization.

The CA3318 operates over a wide full scale input voltage range of 4V up to 7.5V with maximum power consumption depending upon the clock frequency selected. When operated from a 5V supply at a clock frequency of 15MHz, the typical power consumption of the CA3318 is 150mW.

The intrinsic high conversion rate makes the CA3318 ideally suited for digitizing high speed signals. The overflow bit makes possible the connection of two or more CA3318s in series to increase the resolution of the conversion system. A series connection of two CA3318s may be used to produce a 9-bit high speed converter. Operation of two CA3318s in parallel doubles the conversion speed (i.e., increases the sampling rate from 15MHz to 30MHz).

256 paralleled auto balanced voltage comparators measure the input voltage with respect to a known reference to produce the parallel bit outputs in the CA3318.

255 comparators are required to quantize all input voltage levels in this 8-bit converter, and the additional comparator is required for the overflow bit.

## **Ordering Information**

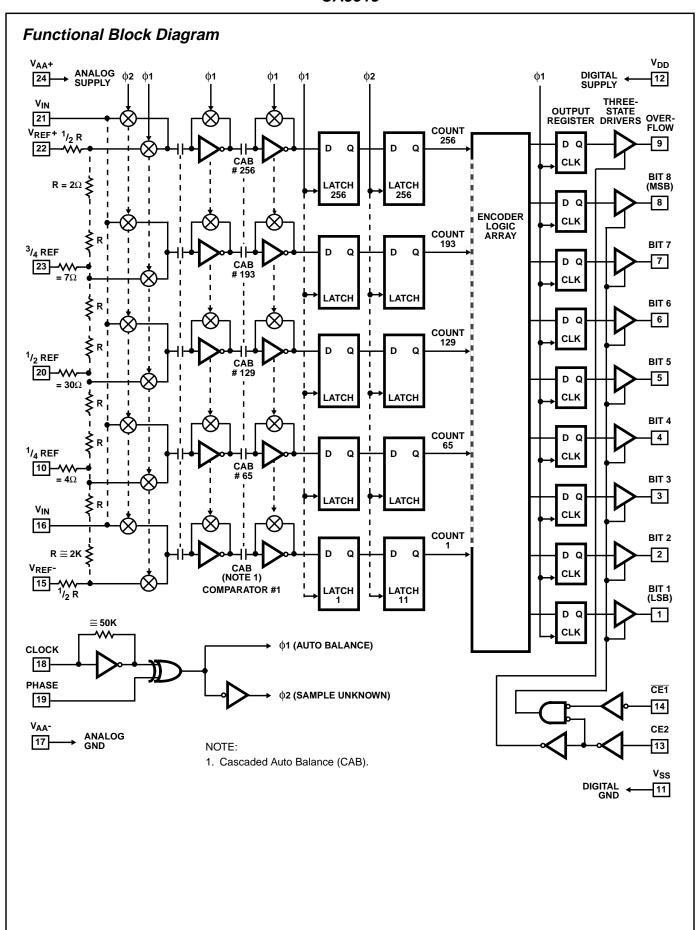
PART NUMBER LINEARITY (INL, DNL)		SAMPLING RATE	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
CA3318CE	±1.5 LSB	15MHz (67ns)	-40 to 85	24 Ld PDIP	E24.6
CA3318CM	±1.5 LSB	15MHz (67ns)	-40 to 85	24 Ld SOIC	M24.3
CA3318CD	±1.5 LSB	15MHz (67ns)	-40 to 85	24 Ld SBDIP	D24.6

#### **Pinout**

CA3318 (PDIP, SBDIP, SOIC) TOP VIEW

(LSB) B1 1		24 V <sub>AA</sub> + (ANA. SUP.)
B2 2		23 <sup>3</sup> / <sub>4</sub> R
В3 3	- A	22 V <sub>REF</sub> +
B4 4	0.10	21 V <sub>IN</sub>
B5 5		20 p
B6 6		19 PHASE
B7 7		18 CLK
(MSB) B8 8		17 V <sub>AA</sub> - (ANA. GND)
OVERFLOW 9		16 V <sub>IN</sub>
<sup>1</sup> / <sub>4</sub> R 10		15 V <sub>REF</sub> -
(DIG. GND) V <sub>SS</sub> 11		14 CE1
(DIG. SUP.) V <sub>DD</sub> 12		13 CE2





#### CA3318

#### **Absolute Maximum Ratings**

# DC Supply Voltage Range ( $V_{DD}$ or $V_{AA}+$ ) ..... -0.5V to +8V (Referenced to $V_{SS}$ or $V_{AA}$ - Terminal, Whichever is More Negative) Input Voltage Range CE2 and $\overline{\text{CE1}}$ .... $V_{AA}$ - -0.5V to $V_{DD}$ + 0.5V Clock, Phase, $V_{REF}$ -, $V_{AE}$ - .... $V_{AA}$ - -0.5V to $V_{AA}$ + + 0.5V Clock, Phase, $V_{REF}$ -, $V_{AE}$ - .... $V_{AE}$ - .0.5V to $V_{DD}$ + 0.5V $V_{IN}$ , $V_{AA}$ - .0.5V to $V_{AA}$ - 7.5V Output Voltage Range, ..... $V_{AA}$ - .0.5V to $V_{DD}$ + 0.5V Bits 1-8, Overflow (Outputs Off)

#### **Thermal Information**

Thermal Resistance (Typical, Note 1)	$\theta_{JA}$ ( $^{\circ}C/W$ )	θ <sub>JC</sub> ( <sup>o</sup> C/W)
SBDIP Package	60	22
PDIP Package	60	N/A
SOIC Package	75	N/A
Maximum Junction Temperature		
Ceramic Package		175 <sup>0</sup> C
Plastic Packages		150 <sup>o</sup> C
Maximum Storage Temperature Range	65	5°C to 150°C
Maximum Lead Temperature (Soldering 1	0s)	265 <sup>0</sup> C
(SOIC - Lead Tips Only)		

#### **Operating Conditions**

Operating Voltage Range ( $V_{DD}$  or  $V_{AA}+$ ) ... 4V (Min) to 7.5V (Max) Recommended  $V_{AA}+$  Operating Range ... ...  $V_{DD}\pm1V$  Recommended  $V_{AA}-$  Operating Range ... ...  $V_{SS}\pm1V$  Operating Temperature Range ( $T_A$ ) ... .-40°C to 85°C

Clock, Phase, CE1, CE2, V<sub>IN</sub>, Bits 1-8, Overflow

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTE:

1.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

**Electrical Specifications** At 25°C, V<sub>AA</sub>+ = V<sub>DD</sub> = 5V, V<sub>REF</sub>+ = 6.4V, V<sub>REF</sub>- = V<sub>AA</sub>- = V<sub>SS</sub>, CLK = 15MHz, All Reference Points Adjusted, Unless Otherwise Specified

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
SYSTEM PERFORMANCE	•		•	•	
Resolution		8	-	-	Bits
Integral Linearity Error		-	-	± 1.5	LSB
Differential Linearity Error		-	-	+1, -0.8	LSB
Offset Error, Unadjusted	$V_{IN} = V_{REF} + \frac{1}{2} LSB$	-0.5	4.5	6.4	LSB
Gain Error Unadjusted	$V_{IN} = V_{REF} + - \frac{1}{2} LSB$	-1.5	0	1.5	LSB
DYNAMIC CHARACTERISTICS	<u>'</u>			•	
Maximum Input Bandwidth	(Note 1) CA3318	2.5	5.0	-	MHz
Maximum Conversion Speed	CLK = Square Wave	15	17	-	MSPS
Signal to Noise Ratio (SNR)	f <sub>S</sub> = 15MHz, f <sub>IN</sub> = 100kHz	-	47	-	dB
= RMSSignal RMSNoise	$f_S = 15MHz$ , $f_{IN} = 4MHz$	-	43	-	dB
Signal to Noise Ratio (SINAD)	f <sub>S</sub> = 15MHz, f <sub>IN</sub> = 100kHz	-	45	-	dB
= RMSSignal RMSNoise+Distortion	$f_S = 15MHz$ , $f_{IN} = 4MHz$	-	35	-	dB
Total Harmonic Distortion, THD	f <sub>S</sub> = 15MHz, f <sub>IN</sub> = 100kHz	-	-46	-	dBc
	$f_S = 15MHz$ , $f_{IN} = 4MHz$	-	-36	-	dBc
Effective Number of Bits (ENOB)	f <sub>S</sub> = 15MHz, f <sub>IN</sub> = 100kHz	-	7.2	-	Bits
	$f_S = 15MHz$ , $f_{IN} = 4MHz$	-	5.5	-	Bits
Differential Gain Error	Unadjusted	-	2	-	%
Differential Phase Error	Unadjusted	-	1	-	%
ANALOG INPUTS	•	•	•	•	
Full Scale Range, V <sub>IN</sub> and (V <sub>REF</sub> +) - (V <sub>REF</sub> -)	Notes 2, 4	4	-	7	V
Input Capacitance, V <sub>IN</sub>		-	30	-	pF
Input Current, V <sub>IN</sub> , (See Text)	V <sub>IN</sub> = 5V, V <sub>REF</sub> + = 5V	-	-	3.5	mA
REFERENCE INPUTS					
Ladder Impedance		270	500	800	Ω

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL INPUTS					
Low Level Input Voltage, V <sub>OL</sub>					
CE1, CE2	Note 4	-	-	0.2V <sub>DD</sub>	V
Phase, CLK	Note 4	-	-	0.2V <sub>AA</sub>	V
High Level Input Voltage, VIN					
CE1, CE2	Note 4	0.7V <sub>DD</sub>	-	-	V
Phase, CLK	Note 4	0.7V <sub>AA</sub>	ı	-	V
Input Leakage Current, I <sub>I</sub> (Except CLK Input)	Note 3	-	±0.2	±5	μΑ
Input Capacitance, C <sub>I</sub>		-	3	-	pF
DIGITAL OUTPUTS					
Output Low (Sink) Current	$V_0 = 0.4V$	4	10	-	mA
Output High (Source) Current	V <sub>O</sub> = 4.5V	-4	-6	-	mA
Three-State Output Off-State Leakage Current, IOZ		-	±0.2	±5	μΑ
Output Capacitance, CO		-	4	-	pF
TIMING CHARACTERISTICS					
Auto Balance Time (φ1)		33	-	∞	ns
Sample Time (\phi2)	Note 4	25	-	500	ns
Aperture Delay		-	15	-	ns
Aperture Jitter		-	100	-	ps
Data Valid Time, t <sub>D</sub>	Note 4	-	50	65	ns
Data Hold Time, t <sub>H</sub>	Note 4	25	40	-	ns
Output Enable Time, t <sub>EN</sub>		-	18	-	ns
Output Disable Time, t <sub>DIS</sub>		-	18	-	ns
POWER SUPPLY CHARACTERISTICS	•				
Device Current (I <sub>DD</sub> + I <sub>A</sub> ) (Excludes I <sub>REF</sub> )	Continuous Conversion (Note 4)	-	30	60	mA
	Auto Balance (φ1)	-	30	60	mA

#### NOTES:

- 1. A full scale sine wave input of greater than  $f_{CLOCK}/2$  or the specified input bandwidth (whichever is less) may cause an erroneous code. The -3dB bandwidth for frequency response purposes is greater than 30MHz.
- 2.  $V_{IN}$  (Full Scale) or  $V_{REF}$ + should not exceed  $V_{AA}$ + + 1.5V for accuracy.
- 3. The clock input is a CMOS inverter with a  $50k\Omega$  feedback resistor and may be AC coupled with  $1V_{P-P}$  minimum source.
- 4. Parameter not tested, but guaranteed by design or characterization.

# **Timing Waveforms**

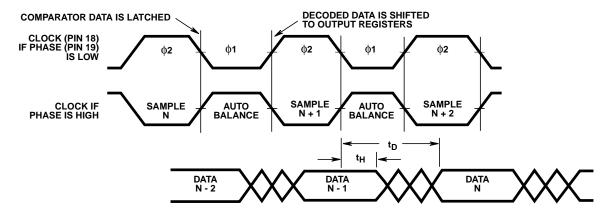


FIGURE 1. INPUT TO OUTPUT TIMING DIAGRAM

# Timing Waveforms (Continued)

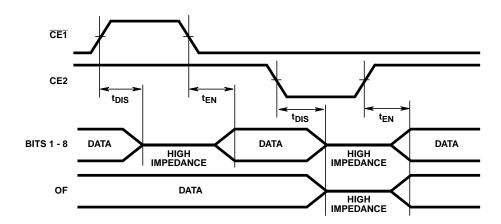


FIGURE 2. OUTPUT ENABLE TIMING DIAGRAM

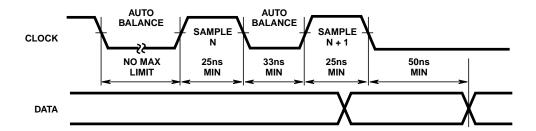


FIGURE 3A. STANDBY IN INDEFINITE AUTO BALANCE (SHOWN WITH PHASE = LOW)

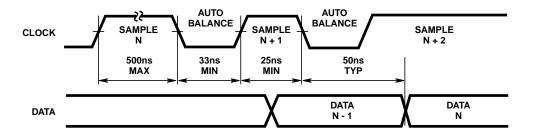


FIGURE 3B. STANDBY IN SAMPLE (SHOWN WITH PHASE = LOW)
FIGURE 3. PULSE MODE OPERATION

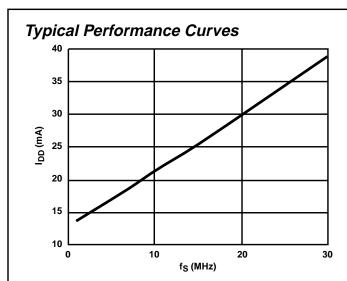


FIGURE 4. DEVICE CURRENT vs SAMPLE FREQUENCY

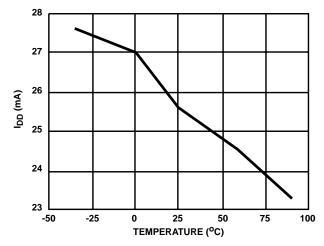


FIGURE 5. DEVICE CURRENT vs TEMPERATURE

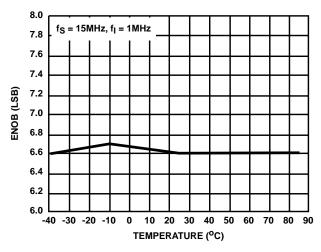


FIGURE 6. ENOB vs TEMPERATURE

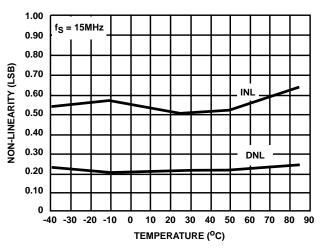


FIGURE 7. NON-LINEARITY vs TEMPERATURE

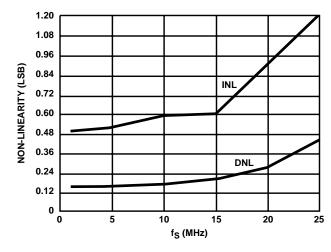


FIGURE 8. NON-LINEARITY vs SAMPLE FREQUENCY

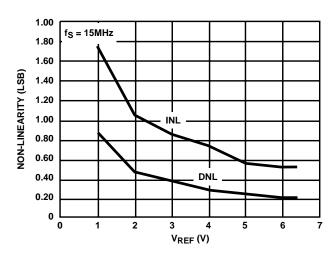


FIGURE 9. NON-LINEARITY vs REFERENCE VOLTAGE

#### Typical Performance Curves (Continued)

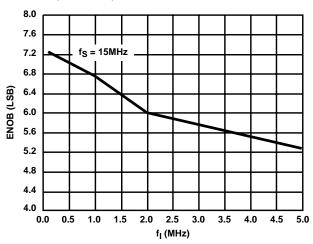


FIGURE 10. ENOB vs INPUT FREQUENCY

## Pin Descriptions

PIN	NAME	DESCRIPTION				
1	B1	Bit 1 (LSB)	Output Data Bits			
2	B2	Bit 2	(High = True)			
3	В3	Bit 3				
4	B4	Bit 4				
5	B5	Bit 5				
6	B6	Bit 6				
7	В7	Bit 7				
8	B8	Bit 8 (MSB)				
9	OF	Overflow				
10	<sup>1</sup> / <sub>4</sub> R	Reference Lade	der <sup>1</sup> / <sub>4</sub> Point			
11	V <sub>SS</sub>	Digital Ground				
12	V <sub>DD</sub>	Digital Power S	Supply, +5V			
13	CE2	Three-State Output Enable Input, Active Low, See Truth Table.				
14	CE1	Three-State Output Enable Input Active High. See Truth Table.				
15	V <sub>REF</sub> -	Reference Volt	age Negative Input			
16	V <sub>IN</sub>	Analog Signal Input				
17	V <sub>AA</sub> -	Analog Ground				
18	CLK	Clock Input				
19	PHASE	Sample clock phase control input. When PHASE is low, "Sample Unknown" occurs when the clock is low and "Auto Balance" occurs when the clock is high (see text).				
20	<sup>1</sup> / <sub>2</sub> R	Reference Lad	der Midpoint			
21	V <sub>IN</sub>	Analog Signal I	nput			
22	V <sub>REF</sub> +	Reference Voltage Positive Input				
23	<sup>3</sup> / <sub>4</sub> R	Reference Ladder <sup>3</sup> / <sub>4</sub> Point				
24	V <sub>AA</sub> +	Analog Power	Supply, +5V			

#### **CHIP ENABLE TRUTH TABLE**

CE1	CE2	B1 - B8	OF		
0	1	Valid	Valid		
1	1	Three-State	Valid		
Х	0	Three-State	Three-State		

X = Don't Care

# Theory of Operation

A sequential parallel technique is used by the CA3318 converter to obtain its high speed operation. The sequence consists of the "Auto-Balance" phase,  $\phi1$ , and the "Sample Unknown" phase,  $\phi2$ . (Refer to the circuit diagram.) Each conversion takes one clock cycle (see Note). With the phase control (pin 19) high, the "Auto-Balance" ( $\phi1$ ) occurs during the high period of the clock cycle, and the "Sample Unknown" ( $\phi2$ ) occurs during the low period of the clock cycle.

NOTE: The device requires only a single phase clock The terminology of  $\phi 1$  and  $\phi 2$  refers to the high and low periods of the same clock.

During the "Auto-Balance" phase, a transmission switch is used to connect each of the first set of 256 commutating capacitors to their associated ladder reference tap. Those tap voltages will be as follows:

$$V_{TAP}(N) = [(N/256) V_{REF}] - (1/512) V_{REF}]$$
  
=  $[(2N - 1)/512] V_{REF}$ ,

Where:

 $V_{TAP}$  (n) = reference ladder tap voltage at point n,

 $V_{REF}$  = voltage across  $V_{REF}$ - to  $V_{REF}$ +, N = tap number (1 through 256).

The other side of these capacitors are connected to single-stage amplifiers whose outputs are shorted to their inputs by switches. This balances the amplifiers at their intrinsic trip points, which is approximately  $(V_{AA} + - V_{AA} -)/2$ . The first set of capacitors now charges to their associated tap voltages.

At the same time a second set of commutating capacitors and amplifiers is also auto-balanced. The balancing of the second-stage amplifier at its intrinsic trip point removes any tracking differences between the first and second amplifier stages. The cascaded auto-balance (CAB) technique, used here, increases comparator sensitivity and temperature tracking.

In the "Sample Unknown" phase, all ladder tap switches and comparator shorting switches are opened. At the same time  $V_{\mbox{\footnotesize{IN}}}$  is switched to the first set of commutating capacitors. Since the other end of the capacitors are now looking into an effectively open circuit, any input voltage that differs from the previous tap voltage will appear as a voltage shift at the comparator amplifiers. All comparators that had tap voltages greater than  $V_{\mbox{\footnotesize{IN}}}$  will go to a "high" state at their outputs. All comparators that had tap voltages lower than  $V_{\mbox{\footnotesize{IN}}}$  will go to a "low" state.

The status of all these comparator amplifiers is AC coupled through the second-stage comparator and stored at the end of this phase ( $\phi$ 2) by a latching amplifier stage. The latch feeds a second latching stage, triggered at the end of  $\phi$ 1. This delay allows comparators extra settling time. The status of the comparators is decoded by a 256 to 9-bit decoder array, and the results are clocked into a storage register at the end of the next  $\phi$ 2.

A 3-stage buffer is used at the output of the 9 storage registers which are controlled by two chip-enable signals. CE1 will independently disable B1 through B6 when it is in a high state. CE2 will independently disable B1 through B8 and the OF buffers when it is in the low state.

To facilitate usage of this device, a phase control input is provided which can effectively complement the clock as it enters the chip.

#### **Continuous-Clock Operation**

One complete conversion cycle can be traced through the CA3318 via the following steps. (Refer to timing diagram.) With the phase control in a "low" state, the rising edge of the clock input will start a "sample" phase. During this entire "high" state of the clock, the comparators will track the input voltage and the first-stage latches will track the comparator outputs. At the falling edge of the clock, all 256 comparator outputs are captured by the 256 latches. This ends the "sample" phase and starts the "auto-balance" phase for the comparators. During this "low" state of the clock, the output of the latches settles and is captured by a second row of latches when the clock returns high. The second-stage latch output propagates through the decode array, and a 9-bit code appears at the D inputs of the output registers. On the next falling edge of the clock, this 9-bit code is shifted into the output registers and appears with time delay to as valid data at the output of the three-state drivers. This also marks the end of the next "sample" phase, thereby repeating the conversion process for this next cycle.

#### **Pulse-Mode Operation**

The CA3318 needs two of the same polarity clock edges to complete a conversion cycle: If, for instance, a negative going clock edge ends sample "N", then data "N" will appear after the next negative going edge. Because of this requirement, and because there is a maximum sample time of 500ns (due to capacitor droop), most pulse or intermittent sample applications will require double clock pulsing.

If an indefinite standby state is desired, standby should be in auto-balance, and the operation would be as in Figure 3A.

If the standby state is known to last less than 500ns and lowest average power is desired, then operation could be as in Figure 3B.

#### **Increased Accuracy**

In most cases the accuracy of the CA3318 should be sufficient without any adjustments. In applications where accuracy is of utmost importance, five adjustments can be made to obtain better accuracy, i.e., offset trim; gain trim; and  $^{1}/_{4}$ ,  $^{1}/_{2}$  and  $^{3}/_{4}$  point trim.

#### **Offset Trim**

In general, offset correction can be done in the preamp circuitry by introducing a DC shift to  $V_{\rm IN}$  or by the offset trim of the op amp. When this is not possible the  $V_{\rm REF}$ - input can be adjusted to produce an offset trim. The theoretical input voltage to produce the first transition is  $^{1}/_{2}$  LSB. The equation is as follows:

$$V_{IN}$$
 (0 to 1 transition) =  $^{1}/_{2}$  LSB =  $^{1}/_{2}$  ( $V_{REF}/256$ ) =  $V_{REF}/512$ .

If  $V_{IN}$  for the first transition is less than the theoretical, then a single-turn  $50\Omega$  pot connected between  $V_{REF}$ - and ground will accomplish the adjustment. Set  $V_{IN}$  to 1/2 LSB and trim the pot until the 0-to-1 transition occurs.

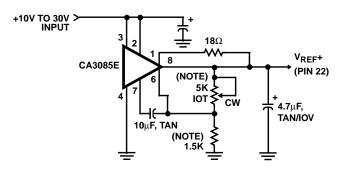
If  $V_{IN}$  for the first transition is greater than the theoretical, then the  $50\Omega$  pot should be connected between  $V_{REF}$ - and a negative voltage of about 2 LSBs. The trim procedure is as stated previously.

#### **Gain Trim**

In general, the gain trim can also be done in the preamp circuitry by introducing a gain adjustment for the op amp. When this is not possible, then a gain adjustment circuit should be made to adjust the reference voltage. To perform this trim,  $V_{IN}$  should be set to the 255 to overflow transition. That voltage is  $^{1}/_{3}$  LSB less than  $V_{REF}+$  and is calculated as follows:

$$V_{IN}$$
 (255 to 256 transition) =  $V_{REF}$  -  $V_{REF}/512$   
=  $V_{REF}(511/512)$ .

To perform the gain trim, first do the offset trim and then apply the required  $V_{\text{IN}}$  for the 255 to overflow transition. Now adjust  $V_{\text{REF}}+$  until that transition occurs on the outputs.

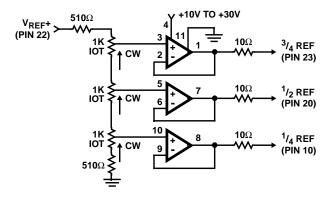


NOTE: Bypass  $V_{REF}$ + to analog GND near A/D with  $0.1\mu F$  ceramic cap. Parts noted should have low temperature drift.

FIGURE 11. TYPICAL VOLTAGE REFERENCE SOURCE FOR DRIVING  $V_{REF}$ + INPUT

#### <sup>1</sup>/<sub>4</sub> Point Trims

The  $^{1}/_{4}$ ,  $^{1}/_{2}$  and  $^{3}/_{4}$  points on the reference ladder are brought out for linearity adjusting or if the user wishes to create a nonlinear transfer function. The  $^{1}/_{4}$  points can be driven by the reference drivers shown (Figure 12) or by 2-K pots connected between  $V_{REF}+$  and  $V_{REF}-$ . The  $^{1}/_{2}$  (mid-) point should be set first by applying an input of 257/512 x ( $V_{REF}$ ) and adjusting for an output changing from 128 to 129. Similarly the  $^{1}/_{4}$  and  $^{3}/_{4}$  points can be set with inputs of 129/512 and 385/512 x ( $V_{REF}$ ) and adjusting for counts of 192 to 193 and 64 to 65. (Note that the points are actually  $^{1}/_{4}$ ,  $^{1}/_{2}$  and  $^{3}/_{4}$  of full scale +1 LSB.)



#### NOTES:

- 1. All Op Amps =  $\frac{3}{4}$  CA324E.
- 2. Bypass all reference points to analog ground near A/D with 0.1μF
- 3. Adjust  $V_{REF+}$  first, then  $\frac{1}{3}$ ,  $\frac{3}{4}$  and  $\frac{1}{4}$  points.

FIGURE 12. TYPICAL <sup>1</sup>/<sub>4</sub> POINT DRIVERS FOR ADJUSTING LINEARITY (USE FOR MAXIMUM LINEARITY)

#### 9-Bit Resolution

To obtain 9-bit resolution, two CA3318s can be wired together. Necessary ingredients include an open-ended ladder network, an overflow indicator, three-state outputs, and chipenable controls - all of which are available on the CA3318.

The first step for connecting a 9-bit circuit is to totem-pole the ladder networks, as illustrated in Figure 13. Since the absolute resistance value of each ladder may vary, external trim of the mid-reference voltage may be required.

The overflow output of the lower device now becomes the ninth bit. When it goes high, all counts must come from the upper device. When it goes low, all counts must come from the lower device. This is done simply by connecting the lower overtlow signal to the CE1 control of the lower A/D converter and the CE2 control of the upper A/D converter. The three-state outputs of the two devices (bits 1 through 8) are now connected in parallel to complete the circuitry. The complete circuit for a 9-bit A/D converter is shown in Figure 13.

#### **Grounding/Bypassing**

The analog and digital supply grounds of a system should be kept separate and only connected at the A/D. This keeps digital ground noise out of the analog data to be converted. Reference drivers, input amps, reference taps, and the  $V_{AA}$  supply should be bypassed at the A/D to the analog side of the ground. See Figure 15 for a block diagram of this concept. All capacitors shown should be low impedance  $0.1\mu F$  ceramics and should be mounted as close to the A/D as possible. If  $V_{AA}+$  is derived from  $V_{DD},$  a small (10 $\Omega$  resistor or inductor and additional filtering (4.7 $\mu F$  tantalum) may be used to keep digital noise out of the analog system.

#### Input Loading

The CA3318 outputs a current pulse to the  $V_{IN}$  terminal at the start of every sample period. This is due to capacitor charging and switch feedthrough and varies with input voltage and sampling rate. The signal source must be capable of recovering from the pulse before the end of the sample period to guarantee a valid signal for the A/D to convert. Suitable high speed amplifiers include the HA-5033, HA-2542; and CA3450. Figure 16 is an example of an amplifier which recovers fast enough for sampling at 15MHz.

#### **Output Loading**

The CMOS digital output stage, although capable of driving large loads, will reflect these loads into the local ground. It is recommended that a local QMOS buffer such as CD74HC541 E be used to isolate capacitive loads.

#### **Definitions**

#### **Dynamic Performance Definitions**

Fast Fourier Transform (FFT) techniques are used to evaluate the dynamic performance of the converter. A low distortion sine wave is applied to the input, it is sampled, and the output is stored in RAM. The data is then transformed into the frequency domain with a 4096 point FFT and analyzed to evaluate the dynamic performance of the A/D. The sine wave input to the part is -0.5dB down from fullscale for all these tests.

#### Signal-to-Noise (SNR)

SNR is the measured RMS signal to RMS noise at a specified input and sampling frequency. The noise is the RMS sum of all of the spectral components except the fundamental and the first five harmonics.

#### Signal-to-Noise + Distortion Ratio (SINAD)

#### **Total Harmonic Distortion (THD)**

SINAD is the measured RMS signal to RMS sum of all other spectral components below the Nyquist frequency excluding DC.

THD is the ratio of the RMS sum of the first 5 harmonic components to the RMS value of the measured input signal.

#### **Effective Number of Bits (ENOB)**

The effective number of bits (ENOB) is derived from the SINAD data. ENOB is calculated from:

 $ENOB = (SINAD - 1.76 + V_{CORR})/6.02,$ 

where:  $V_{CORR} = 0.5 dB$ .

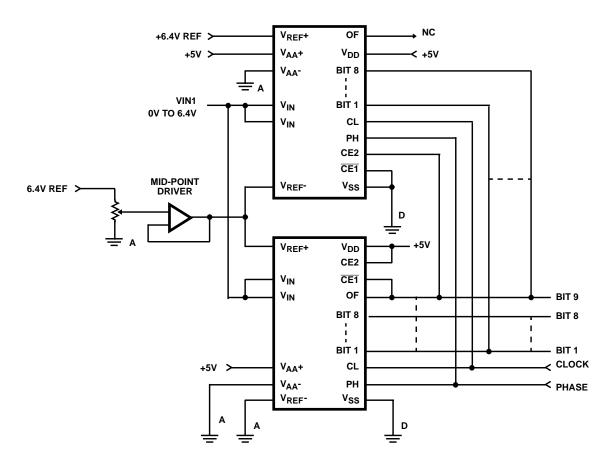


FIGURE 13. USING TWO CA3318s FOR 9-BIT RESOLUTION

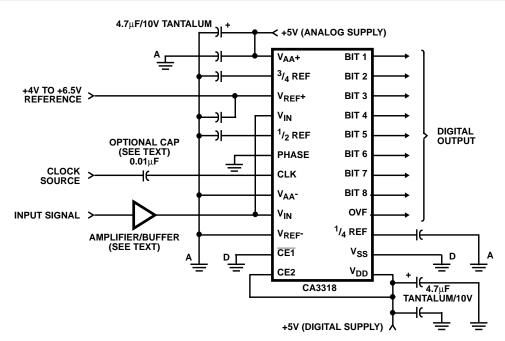


FIGURE 14. TYPICAL CIRCUIT CONFIGURATION FOR THE CA3318 WITH NO LINEARITY ADJUST

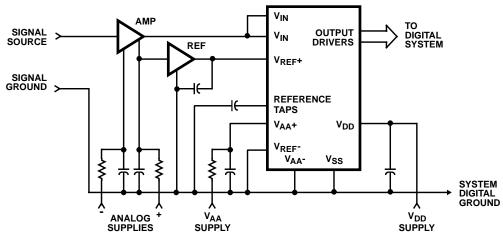


FIGURE 15. TYPICAL SYSTEM GROUNDING/BYPASSING

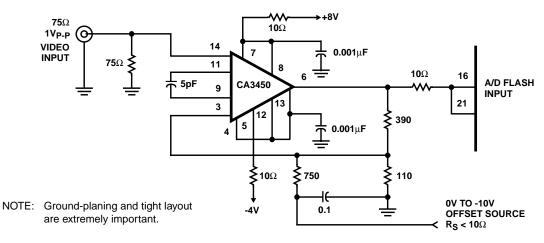


FIGURE 16. TYPICAL HIGH BANDWIDTH AMPLIFIER FOR DRIVING THE CA3318

**TABLE 1. OUTPUT CODE TABLE** 

	(NO INPUT V	TE 1) <b>OLTAGE</b>		BINARY OUTPUT CODE								
CODE DESCRIPTION	V <sub>REF</sub> 6.40V (V)	V <sub>REF</sub> 5.12V (V)	OF	MSB B8	В7	В6	В5	В4	В3	B2	LSB B1	DECIMAL COUNT
Zero	0.00	0.00	0	0	0	0	0	0	0	0	0	0
1 LSB	0.025	0.02	0	0	0	0	0	0	0	0	1	1
2 LSB	0.05	0.04	0	0	0	0	0	0	0	1	0	2
•	•	•					•					•
<sup>1</sup> / <sub>4</sub> Full Scale	1.60	1.28	0	0	1	0	0	0	0	0	0	64
•	•	•					•					•
<sup>1</sup> / <sub>2</sub> Full Scale - 1 LSB	3.175	2.54	0	0	1	1	1	1	1	1	1	127
<sup>1</sup> / <sub>2</sub> Full Scale	3.20	2.56	0	1	0	0	0	0	0	0	0	128
<sup>1</sup> / <sub>2</sub> Full Scale + 1 LSB	3.225	2.58	0	1	0	0	0	0	0	0	1	129
:	•	•					•					•
<sup>3</sup> / <sub>4</sub> Full Scale	4.80	3.84	0	1	1	0	0	0	0	0	0	192
•	•	•					•					•
Full Scale - 1 LSB	6.35	5.08	0	1	1	1	1	1	1	1	0	254
Full Scale	6.375	5.10	0	1	1	1	1	1	1	1	1	255
Over Flow	6.40	5.12	1	1	1	1	1	1	1	1	1	511

NOTE: 1. The voltages listed above are the ideal centers of each output code shown as a function of its associated reference voltage.

#### **Reducing Power**

Most power is consumed while in the auto-balance state. When operating at lower than 15MHz clock speed, power can be reduced by stretching the sample ( $\phi$ 2) time. The constraints are a minimum balance time ( $\phi$ 1) of 33ns, and a maximum sample time of 500ns. Longer sample times cause droop in the auto-balance capacitors. Power can also be reduced in the reference string by switching the reference on only during auto-balance.

#### **Clock Input**

The Clock and Phase inputs feed buffers referenced to  $V_{AA}+$  and  $V_{AA}-$ . Phase should be tied to one of these two potentials, while the clock (if DC coupled) should be driven at least from 0.2 to 0.7 x ( $V_{AA}+-V_{AA}-$ ). The clock may also be AC coupled with at least a  $1V_{P-P}$  swing. This allows TTL drive levels or 5V QMOS levels when  $V_{AA}+$  is greater than 5V.

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